

03-07-2002



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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Chien-Ping HUANG
Tzong-Da HO
Chen-Hsu HSIAO

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

MED 2/19/12

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: February 13, 2001

2. Name and address of receiving party(ies):

Name: Siliconware Precision Industries Co., Ltd.

Address: No. 123, Sec. 3, Da Fong Road,

Tantzu, Taichung, Taiwan, R.O.C.

City: State/Prov.:

Country: ZIP:

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.

Filing date

B. Patent No.(s)

09/946,902

September 5, 2001

FEB 19 2002

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Peter F. Corless

Registration No. 33,860

Address: EDWARDS & ANGELL, LLP

P.O. Box 9169

03/06/2002 DBYRME 00000097 09946902

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City: Boston

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State/Prov.: MA

Country: USA

ZIP: 02209

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☐ Authorized to be charged to deposit account

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter F. Corless

Name of Person Signing

Signature

January 11, 2002
Date

2

Total number of pages including cover sheet, attachments, and

21431

ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar (\$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s)
Full Name(s)

(1) Chien-Ping HUANG (2) Tzong-Da HO
(3) Chen-Hsu HSIAO

Assignee
Name and
Address

hereby sell, assign and transfer to
SILICONWARE PRECISION INDUSTRIES CO., LTD.
No. 123, Sec. 3, Da Fong Rd., Tantz, Taichung, Taiwan, R.O.C.

Title of
Invention

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled

SUBSTRATE OF SEMICONDUCTOR PACKAGE

which application was

Complete
either
a) or b)

a) executed by the undersigned on the day of , 19
b) filed on the day of , 19

Serial No
including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date

Signed at TAICHUNG
this 13th day of February , 2001

Inventor(s)
Full
Signature(s)

INVENTOR(S):
Chien-Ping Huang February 13, 2001
Tzong-Da Ho February 13, 2001
HSIAO, CHENG-HSU February 13, 2001

Witnesses'
Full
Signatures

WITNESSES:
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